Applica	int/Grantee	AMPAK Technology Inc.		· · · · · · · · · · · · · · · · · · ·		
FCC II):	ZQ6-WSDT752BSC				
Section 15.212 Modular Transmitters /						
XR	Request for Mo		nest for Limited Modular Approval	G 1 GUED		
		Requirements	Device Conditions	Comply (Y/N)		
Single Modular Approval Requirements The radio elements must have the radio The module has its own RF shielding."						
1	frequency circ Physical/discr may be locate	cuitry shielded. The shielded capacitors are the shield, but the module assembly.	Shield Can is employed on the board structure, please see exhibition External Photo, the emission measurement was conducted without further shielding added.	Y		
2	modulation/da provided) to e comply with t applicable RS	hall have buffered at a input(s) (if such inputs are usure that the module will he requirements set out in the S standard under conditions at a rates or over-modulation.	inputs, it is integrated on the RF chip	Y		
3	supply regular ensure that the the requireme standard regar power supply device which Requirements standard regar design of the	hall have its own power cion on the module. This is to e module will comply with nts set out in the applicable dless of the design of the ing circuitry in the host houses the module. set out in the applicable dless of the power supplying circuitry in e which houses the module.	The Main chip includes the internal regulator to supply the module main power.	Y		
4	provisions for and antennas Equipment ce contain a deta	nall comply with the external power amplifiers detailed in this standard. The rtification submission shall iled description of the of all antennas that will be module.	The EUT meets the FCC antenna Requirements. Chip Antenna soldered on board	Y		
5	with the applications configuration	nall be tested for compliance cable standard in a stand- ration, i.e. the module must unother device during testing.	The module was tested in a stand-alone configuration via UART Interface.	Y		
6	l .	ransmitter must be either a permanently affixed	In the exhibition OEM manual, there are Instructions given to the OEM on how to label the end product.	Υ		

7	The modular transmitter complies with all specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer will provide adequate instructions along with the module to explain any such requirements. A copy of these instructions is included in this application for equipment authorization:	Instructions in User Manual	Y
8	Address compliance with the Commission's RF exposure limits in Sections 1.1310 and 2.1093. In addition, spread spectrum transmitters operating under Section 15.247 are required to address RF exposure compliance in accordance with Section 15.247(b)(4).	Please refer the Maximum Permissible Exposure Information.	Υ

A limited modular approval may be granted for single or split modular transmitters that do not comply with all of the above requirements, e.g., shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation, if the manufacturer can demonstrate by alternative means in the application for equipment authorization that the modular transmitter meets all the applicable Part 15 requirements under the operating conditions in which the transmitter will be used. Limited modular approval also may be granted in those instances where compliance with RF exposure rules is demonstrated only for particular product configurations. The applicant for certification must state how control of the end product into which the module will be installed will be maintained such that full compliance of the end product is always ensured.

Signature: Cy 75ax Name/Title: Changyi Tsai Manager

Company Name: AMPAK Technology Inc.

Date: 20180712